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N-Channel PowerTrench[®] MOSFET 60 V, 129 A, 3.4 m Ω

Features

- Max $r_{DS(on)}$ = 3.4 m Ω at V_{GS} = 10 V, I_D = 20 A
- Max $r_{DS(on)}$ = 4.1 m Ω at V_{GS} = 8 V, I_D = 18.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

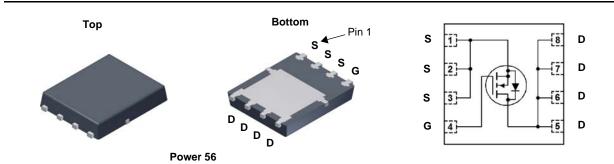


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	129		
	-Continuous	T _C = 100 °C	(Note 5)	82	٨	
D	-Continuous	T _A = 25 °C	(Note 1a)	20	Α	
	-Pulsed		(Note 4)	642		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	228	mJ	
P _D	Power Dissipation	T _C = 25 °C		96	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.3	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86540	FDMS86540	Power 56	13 "	12 mm	3000 units

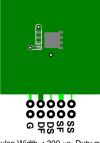
May 2015

FDMS86540
N-Channel
PowerTrench
[®] MOSFET

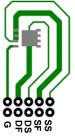
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		28		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.2	4	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C
		V _{GS} = 10 V, I _D = 20 A		2.7	3.4	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 18.5 A		3.1	4.1	mΩ
		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		3.8	4.8	-
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 20 A		73		S
•	Characteristics			1	1	1
C _{iss}	Input Capacitance	V _{DS} = 30 V, V _{GS} = 0 V,		4837	6435	pF
C _{oss}	Output Capacitance	f = 1 MHz		1413	1880	pF
C _{rss}	Reverse Transfer Capacitance			50	90	pF
Rg	Gate Resistance			1.0		Ω
Switching	y Characteristics					
t _{d(on)}	Turn-On Delay Time			28	45	ns
t _r	Rise Time	V _{DD} = 30 V, I _D = 20 A,		16	29	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		32	52	ns
t _f	Fall Time			7.2	15	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		65	90	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 30 V,$		53	75	nC
Q _{gs}	Gate to Source Charge	I _D = 20 A		23		nC
Q _{gd}	Gate to Drain "Miller" Charge			12		nC
Drain-Soເ	urce Diode Characteristics					
N/		$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.70	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 20 \text{ A}$ (Note 2)		0.79	1.3	V
t _{rr}	Reverse Recovery Time			55	88	ns

V SD	Source to Drain Diode Forward voltage	$V_{GS} = 0 V, I_S = 20 A$ (No	ote 2)	0.79	1.3	v
t _{rr}	Reverse Recovery Time		,	55	88	ns
Q _{rr}	Reverse Recovery Charge	– I _F = 20 A, di/dt = 100 A/μs		41	66	nC
t _{rr}	Reverse Recovery Time	I _E = 20 A, di/dt = 300 A/μs		44	70	ns
Q _{rr}	Reverse Recovery Charge	$F = 20 \text{ A}, \text{ u/ut} = 500 \text{ A/}\mu\text{s}$		76	122	nC
	·····g-					

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper

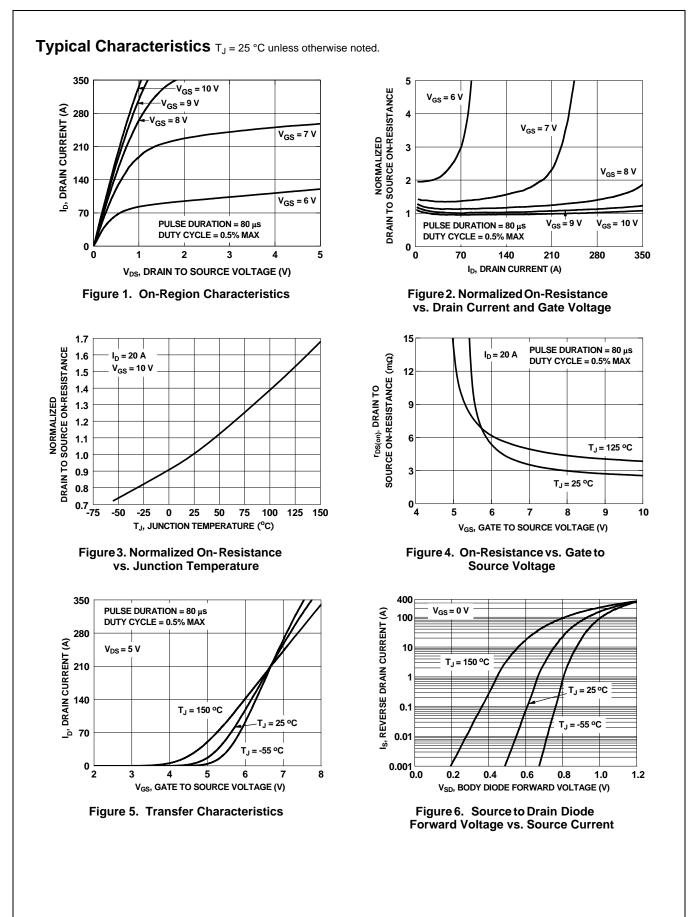


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

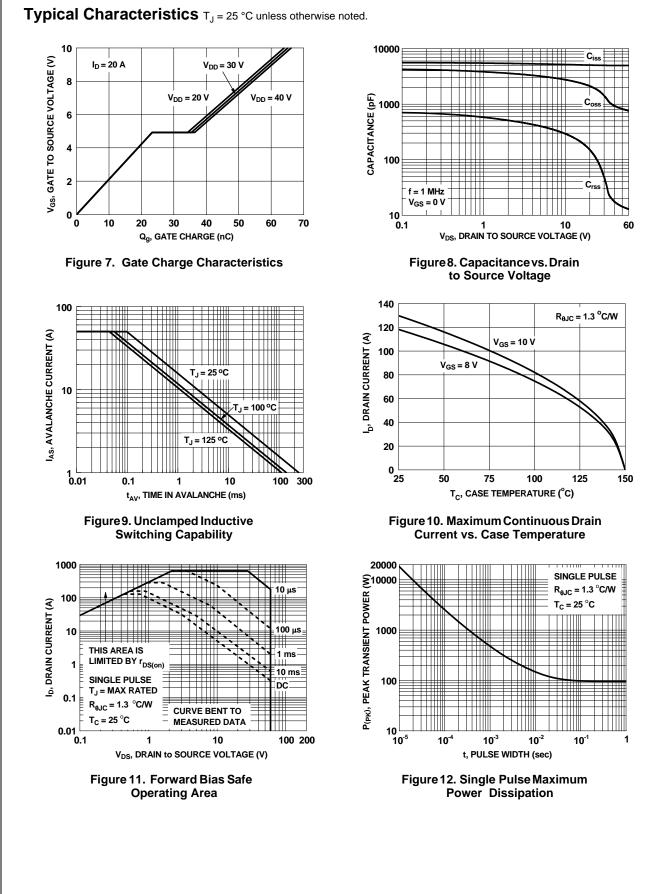
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 39 A, V_{DD} = 54 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 57 A.

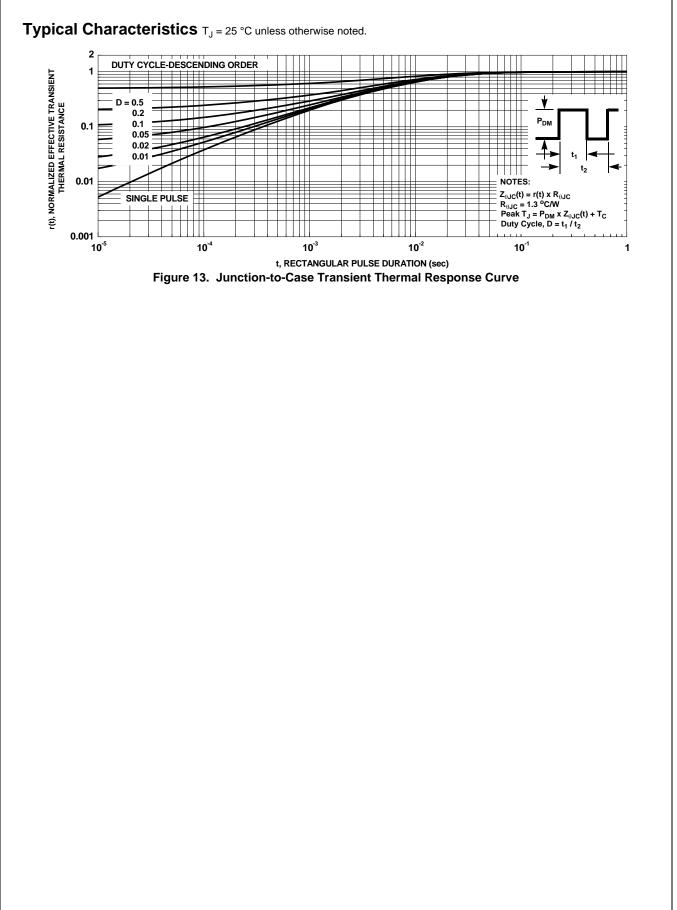
4. Pulse Id please refer to SOA curve for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.









FDMS86540 N-Channel PowerTrench[®] MOSFET



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